FC series ~0201 chip compatible solder paste~

Developed 0201 chip compatible solder paste contributing to the high functionality and miniaturization of electronic devices and modules.

**Characteristics**
- Excellent printing at small aperture, and good wetting characteristics
- Small change of viscosity after continuous printing, can be used for a long period of time

**Printability**

![FC and Conventional paste comparison](image)

**Mount wettability**

![FC and Conventional paste comparison](image)

**Viscosity stability**
- Suppress reaction between solder and activator by stable dispersion of flux ingredients
- Enable long time continuous printing

![Viscosity and Thixotropic index comparison](image)